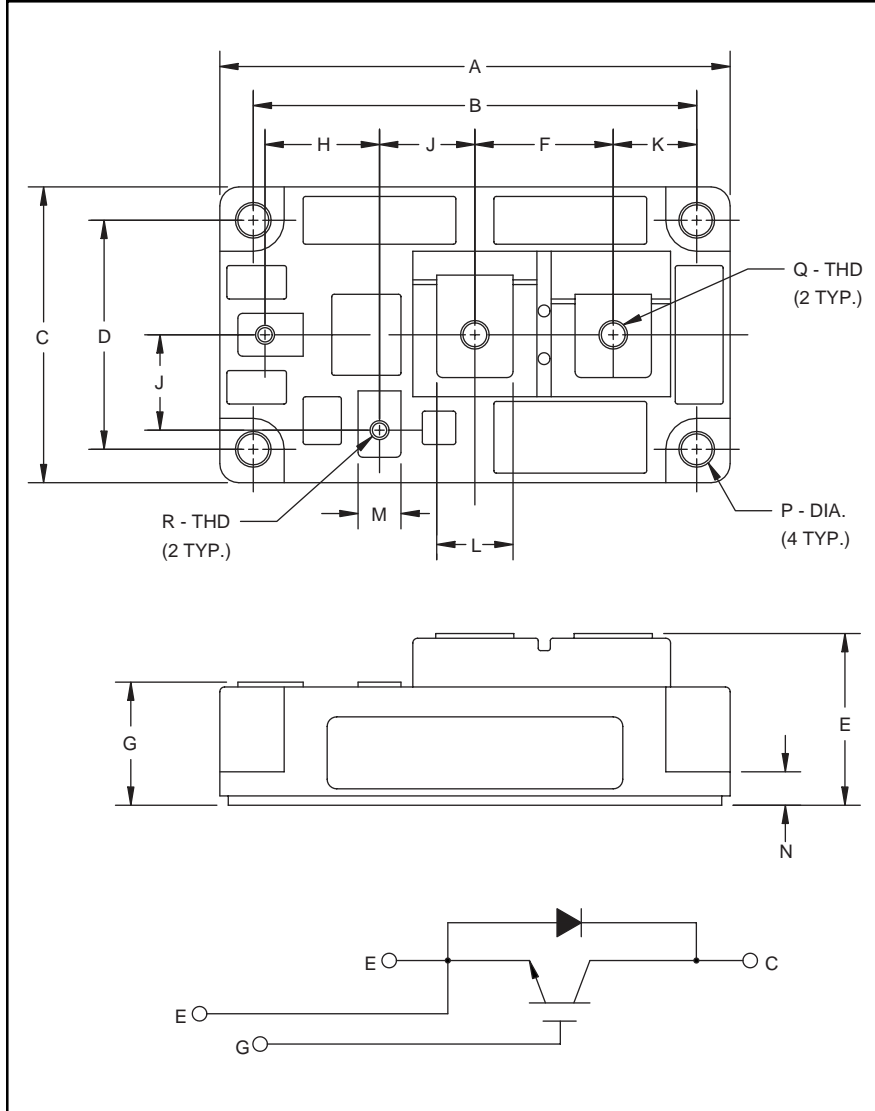


### Single IGBTMOD™ H-Series Module 400 Amperes/1200 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.21	107.0
B	3.661±0.01	93.0±0.25
C	2.44	62.0
D	1.89±0.01	48.0±0.25
E	1.42+0.04/-0.02	36.0+1.0/-0.5
F	1.14	29.0
G	1.02+0.04/-0.2	25.8+1.0/-0.5
H	0.94	24.0

Dimensions	Inches	Millimeters
J	0.79	20.0
K	0.69	17.5
L	0.63	16.0
M	0.35	9.0
N	0.28	7.0
P	0.26 Dia.	Dia. 6.5
Q	M6 Metric	M6
R	M4 Metric	M4



#### Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of one IGBT Transistor in a single configuration with a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

#### Features:

- Low Drive Power
- Low  $V_{CE(sat)}$
- Discrete Super-Fast Recovery (135ns) Free-Wheel Diode
- High Frequency Operation (20-25kHz)
- Isolated Baseplate for Easy Heat Sinking

#### Applications:

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies
- Laser Power Supplies

#### Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM400HA-24H is a 1200V ( $V_{CES}$ ), 400 Ampere Single IGBTMOD™ Power Module.

Type	Current Rating Amperes	$V_{CES}$ Volts (x 50)
CM	400	24

**CM400HA-24H**  
**Single IGBTMOD™ H-Series Module**  
 400 Amperes/1200 Volts

**Absolute Maximum Ratings,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Ratings	Symbol	CM400HA-24H	Units
Junction Temperature	$T_j$	-40 to 150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	$V_{CES}$	1200	Volts
Gate-Emitter Voltage	$V_{GES}$	$\pm 20$	Volts
Collector Current	$I_C$	400	Amperes
Peak Collector Current	$I_{CM}$	800*	Amperes
Diode Forward Current	$I_F$	400	Amperes
Diode Forward Surge Current	$I_{FM}$	800*	Amperes
Power Dissipation	$P_d$	2800	Watts
Max. Mounting Torque M6 Terminal Screws	-	26	in-lb
Max. Mounting Torque M6 Mounting Screws	-	26	in-lb
Module Weight (Typical)	-	400	Grams
V Isolation	$V_{RMS}$	2500	Volts

\* Pulse width and repetition rate should be such that device junction temperature does not exceed the device rating.

**Static Electrical Characteristics,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	$I_{CES}$	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	1.0	mA
Gate Leakage Current	$I_{GES}$	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	0.5	$\mu\text{A}$
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 40\text{mA}, V_{CE} = 10V$	4.5	6.0	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 400A, V_{GE} = 15V$	-	2.5	3.4**	Volts
		$I_C = 400A, V_{GE} = 15V, T_j = 150^\circ\text{C}$	-	2.25	-	Volts
Total Gate Charge	$Q_G$	$V_{CC} = 600V, I_C = 400A, V_{GS} = 15V$	-	2000	-	nC
Diode Forward Voltage	$V_{FM}$	$I_E = 400A, V_{GS} = 0V$	-	-	3.4	Volts

\*\* Pulse width and repetition rate should be such that device junction temperature rise is negligible.

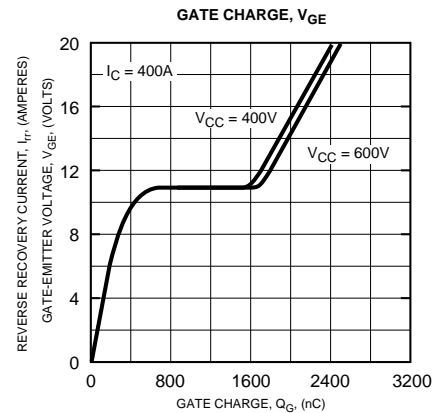
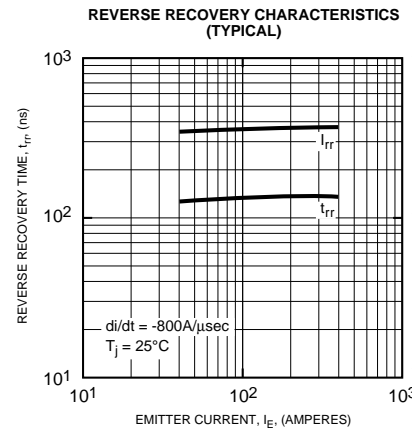
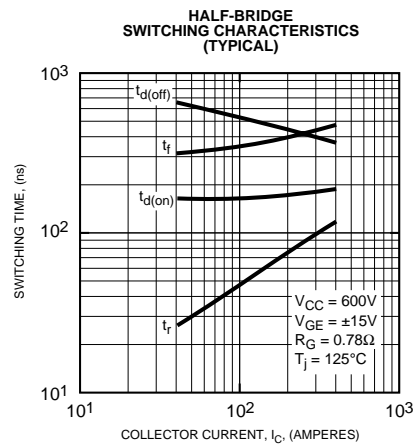
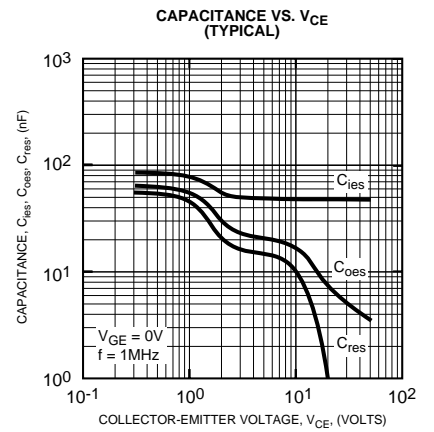
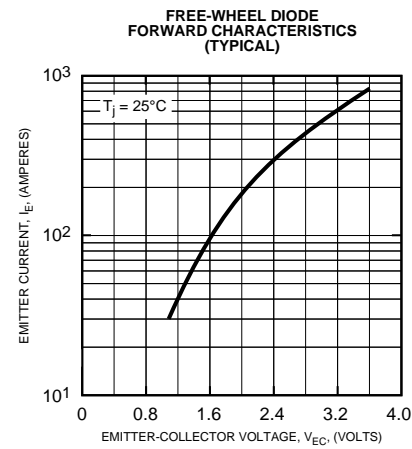
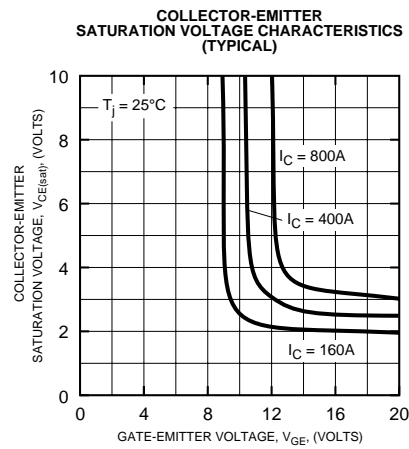
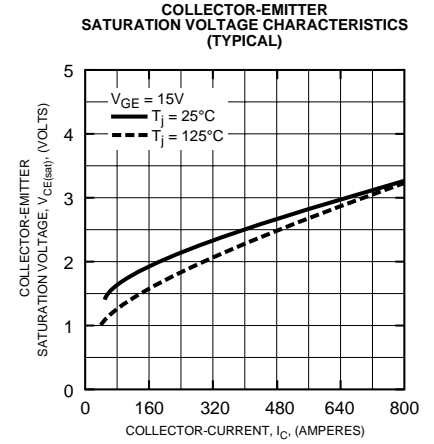
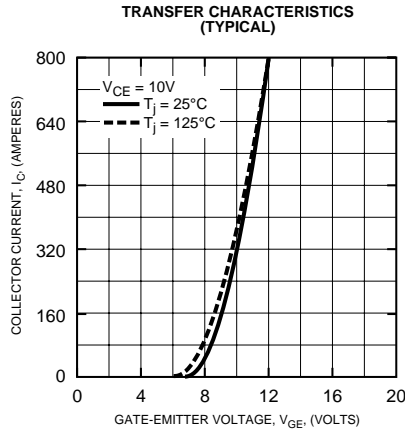
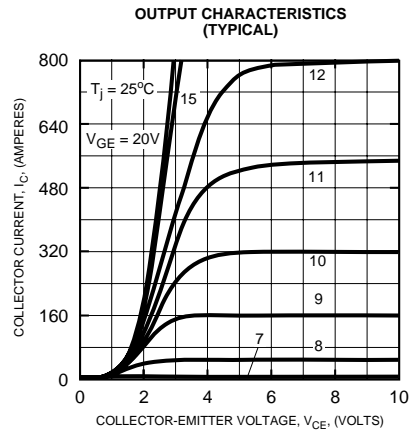
**Dynamic Electrical Characteristics,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	$C_{ies}$		-	-	80	nF
Output Capacitance	$C_{oes}$	$V_{GE} = 0V, V_{CE} = 10V, f = 1\text{MHz}$	-	-	28	nF
Reverse Transfer Capacitance	$C_{res}$		-	-	16	nF
Resistive	Turn-on Delay Time	$V_{CC} = 600V, I_C = 400A$	-	-	300	ns
Load	Rise Time					
Switching	Turn-off Delay Time	$V_{GE1} = V_{GE2} = 15V, R_G = 0.78\Omega$	-	-	350	ns
	Times					
Diode Reverse Recovery Time	$t_{rr}$	$I_E = 400A, di_E/dt = -800A/\mu\text{s}$	-	-	250	ns
Diode Reverse Recovery Charge	$Q_{rr}$	$I_E = 400A, di_E/dt = -800A/\mu\text{s}$	-	2.97	-	$\mu\text{C}$

**Thermal and Mechanical Characteristics,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per IGBT	-	-	0.045	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per FWDi	-	-	0.09	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	-	-	0.040	$^\circ\text{C/W}$

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